NCE N-Channel Enhancement Mode Power MOSFET

Description

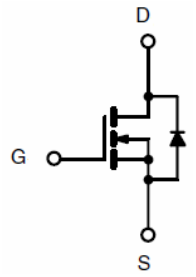
The NCE0106R uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

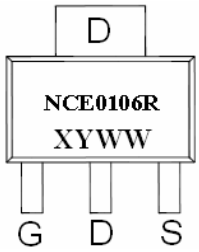
- V_{DS} = 100V,I_D = 6A
  $R_{DS(ON)}$ < 140mΩ @ V_{GS}=10V (Typ:110mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation
- Pb free terminal plating
- RoHS compliant
- Halogen free

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Schematic diagram



SOT-223 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0106R	NCE0106R	SOT-223-3L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	6	A
Drain Current-Continuous(T_C=100℃)	I_D (100℃)	4.2	A
Drain Current-Pulsed (Note 1)	I_{DM}	24	A
Maximum Power Dissipation	P_D	3	W
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	71	℃/W
Thermal Resistance,Junction-to-Case (Note 2)(Drain)	$R_{\theta JC}$	41.7	℃/W

Electrical Characteristics (T_A=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA	100	110	-	V

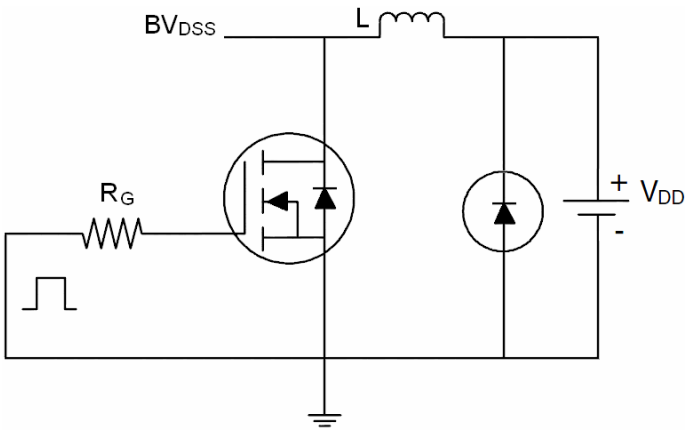
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=100V,V_{GS}=0V	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250μA	1.2	1.8	2.5	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=5A	-	110	140	mΩ
Forward Transconductance	g_{FS}	V_{DS}=5V,I_D=5A	-	8	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C_{lss}	V_{DS}=25V,V_{GS}=0V, F=1.0MHz	-	690	-	PF
Output Capacitance	C_{oss}		-	120	-	PF
Reverse Transfer Capacitance	C_{rss}		-	90	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=50V, R_L=15Ω V_{GS}=10V,R_G=2.5Ω	-	11	-	nS
Turn-on Rise Time	t_r		-	7.4	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	35	-	nS
Turn-Off Fall Time	t_f		-	9.1	-	nS
Total Gate Charge	Q_g	V_{DS}=50V,I_D=5A, V_{GS}=10V	-	15.5		nC
Gate-Source Charge	Q_{gs}		-	3.2	-	nC
Gate-Drain Charge	Q_{gd}		-	4.7	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS}=0V,I_S=6A	-	-	1.2	V
Diode Forward Current (Note 2)	I_S		-	-	6	A

Notes:

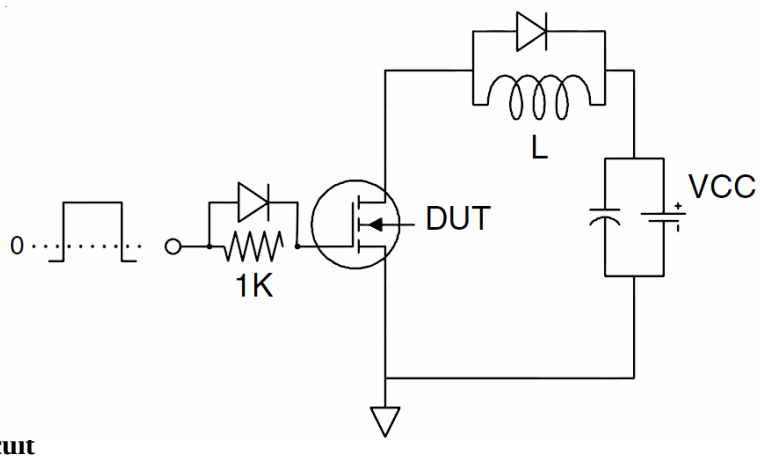
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to product

Test Circuit

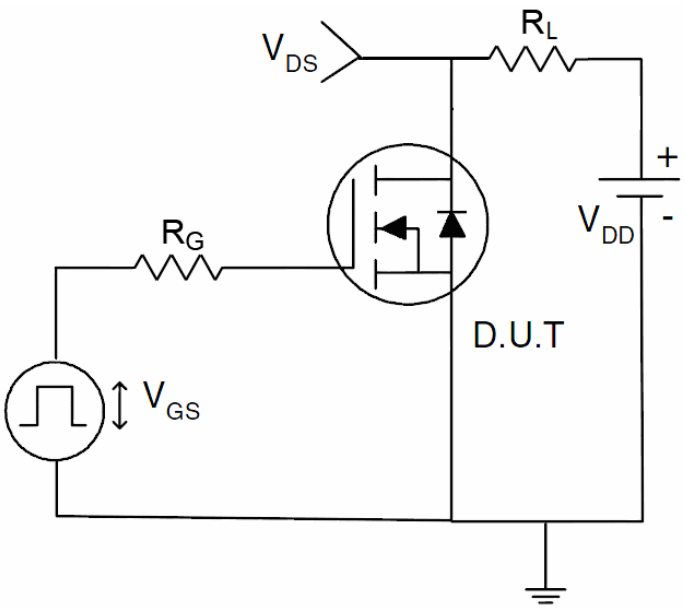
1）E_{AS} test circuit



2）Gate charge test circuit



3）Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (curves)

Figure1. Source-Drain Diode Forward Voltage

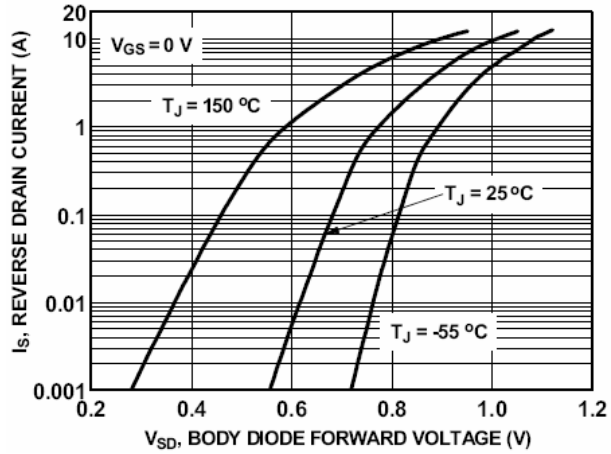


Figure2. Safe operating area

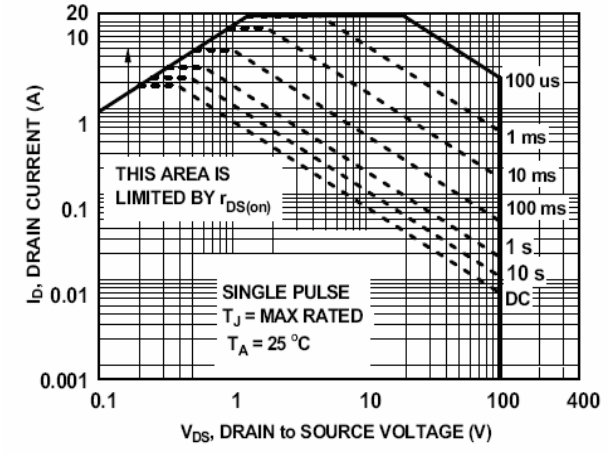


Figure3. Output characteristics

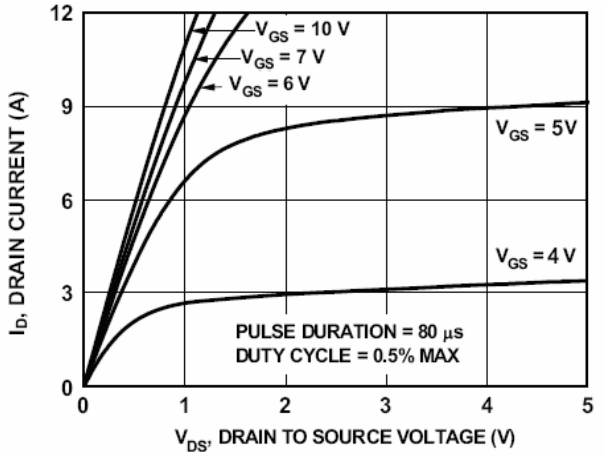


Figure4. Transfer characteristics

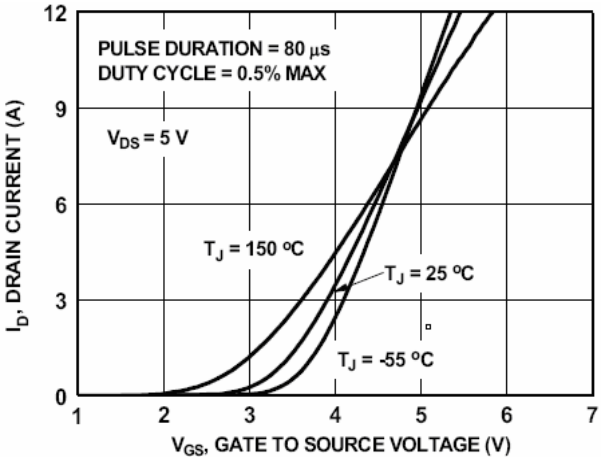


Figure5. Static drain-source on resistance

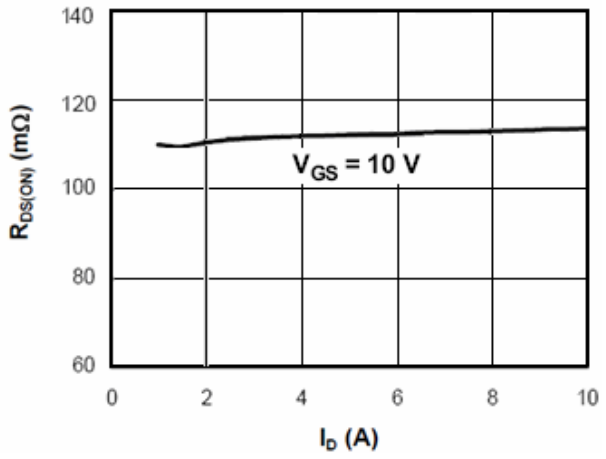


Figure6. $R_{DS(ON)}$ vs Junction Temperature

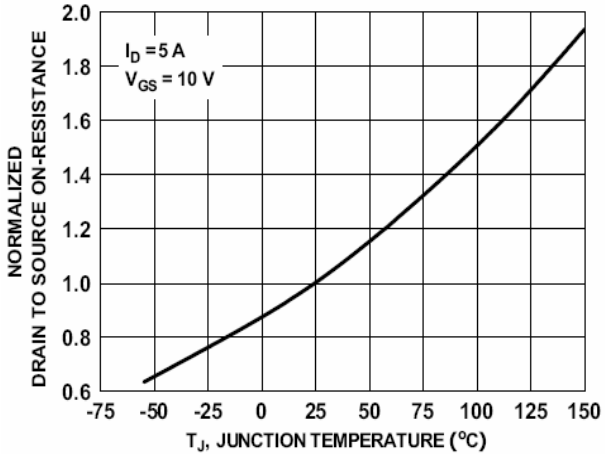


Figure7. BV_{DSS} vs Junction Temperature

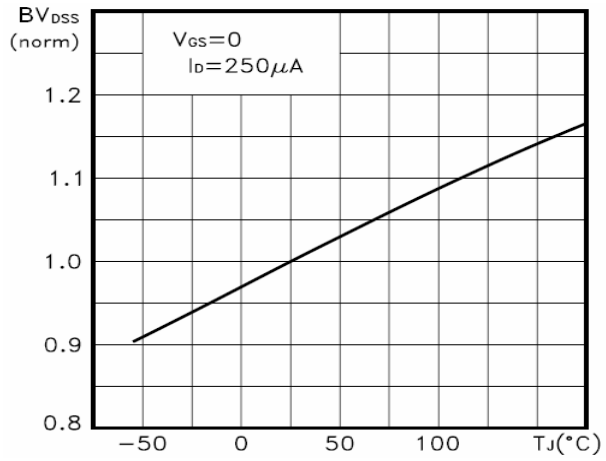


Figure8. $V_{GS(th)}$ vs Junction Temperature

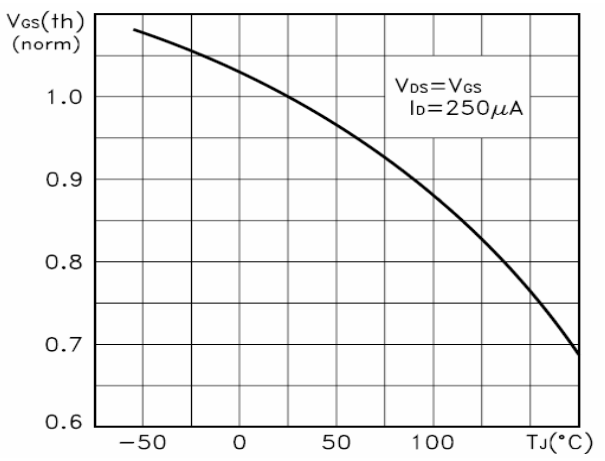


Figure9. Gate charge waveforms

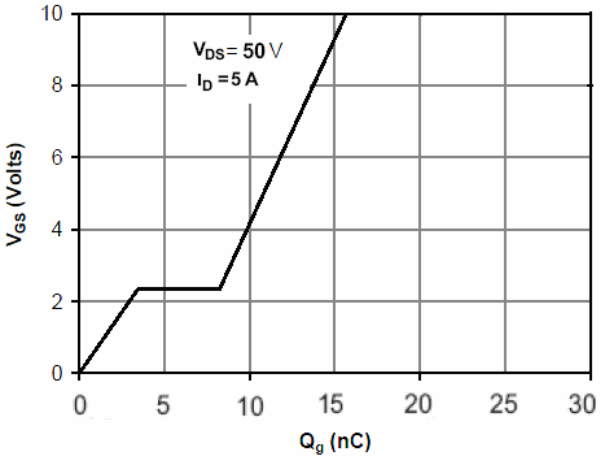
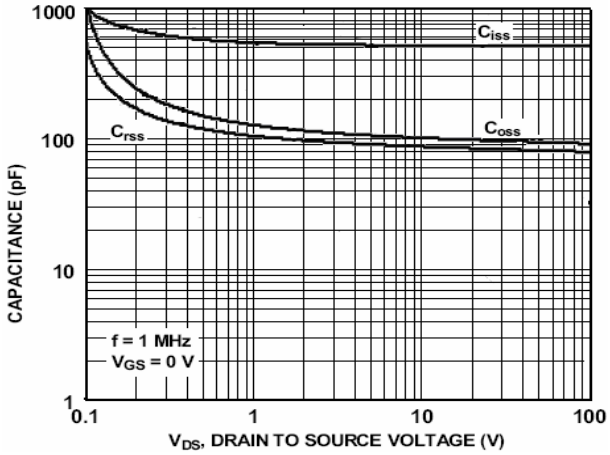


Figure10. Capacitance



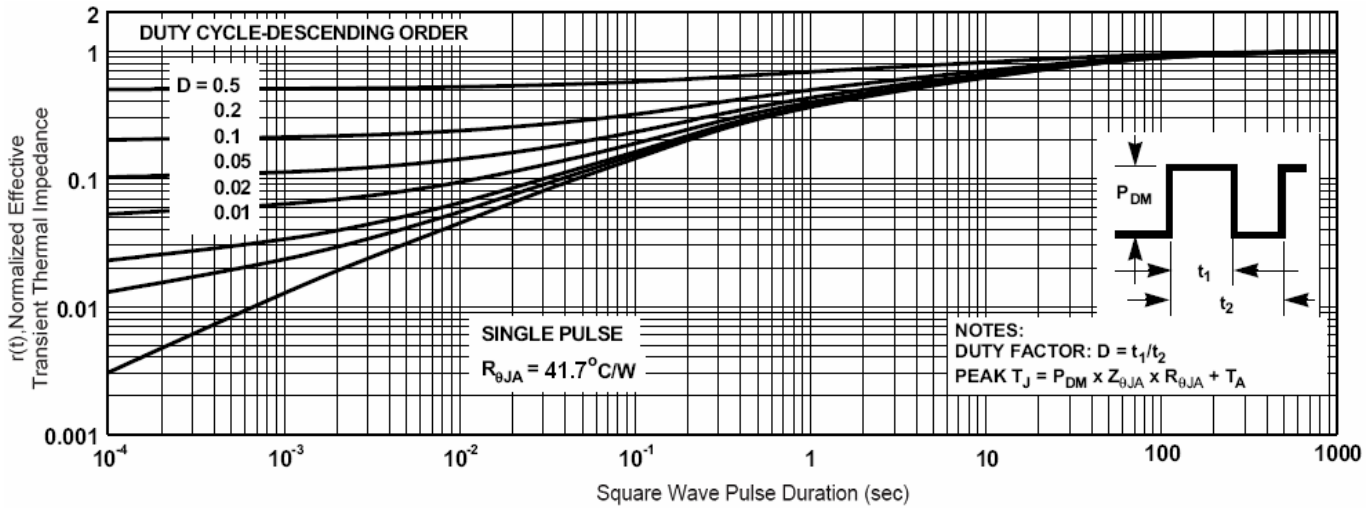


Figure11. Normalized Maximum Transient Thermal Impedance

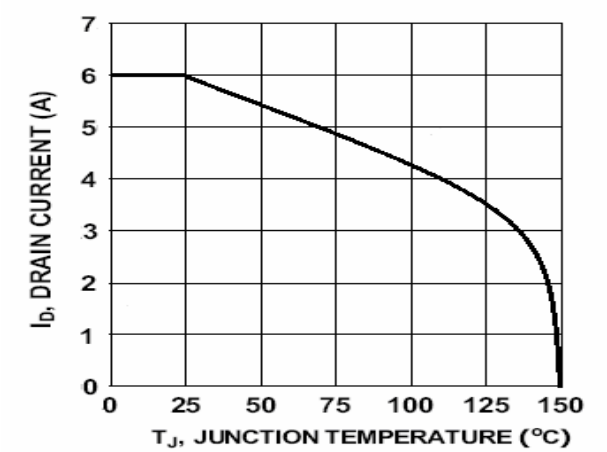
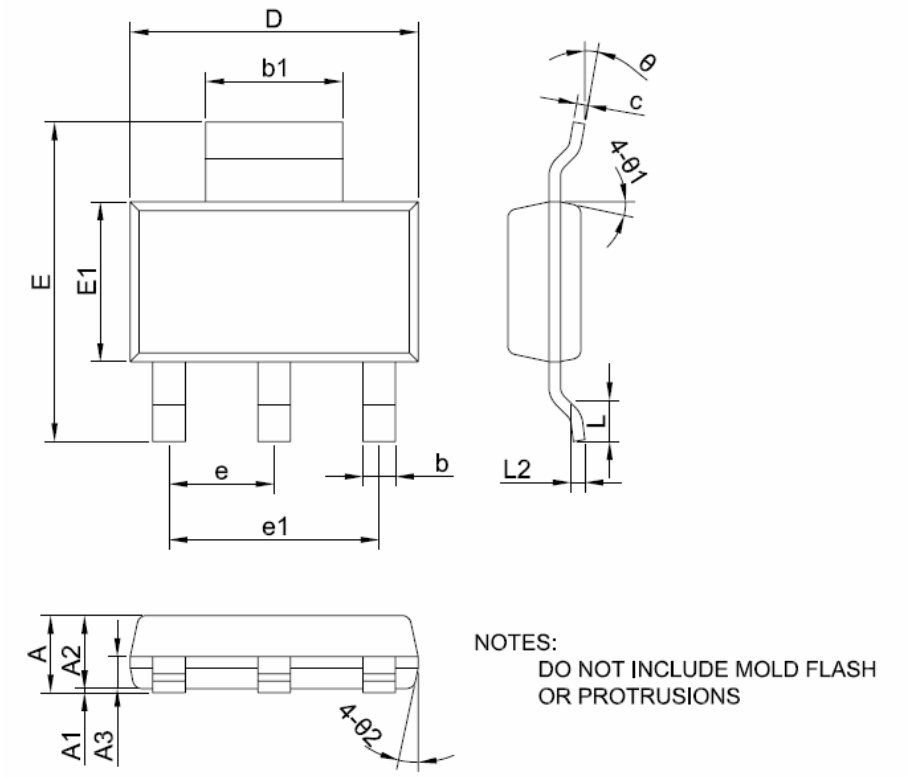
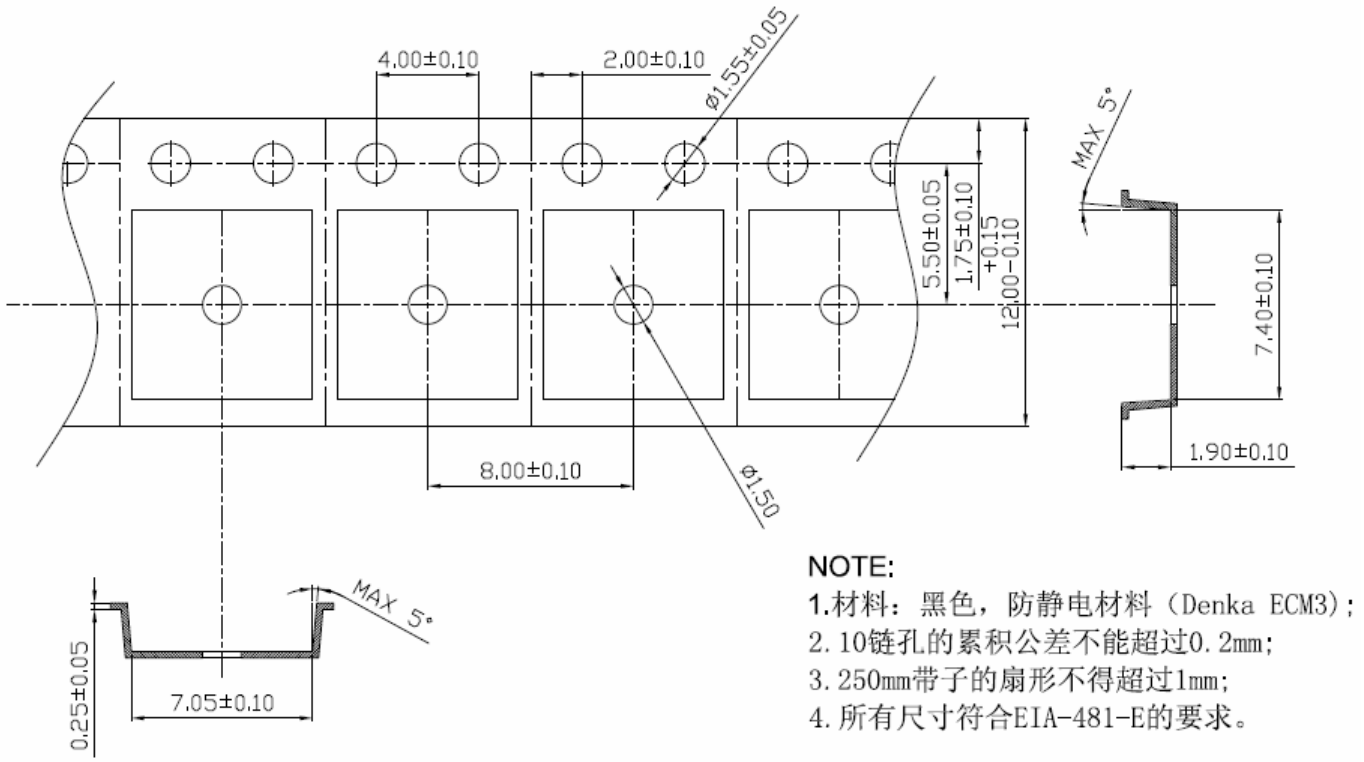


Figure12. I_D vs Junction Temperature

SOT-223 Package Information



SYMBOL	MIN	NOM	MAX
A	1.55	———	1.80
A1	0.02	———	0.12
A2	1.45	1.60	1.75
A3	0.60	0.70	0.80
b	0.60	———	0.80
b1	2.90	———	3.10
c	0.24	———	0.32
D	6.20	6.30	6.50
E	6.70	7.00	7.30
E1	3.30	3.50	3.70
e	2.299REF		
e1	4.598REF		
L	0.90MIN		
L2	0.30BSC		
θ	0°	———	10°
θ_1	10°	12°	14°
θ_2	10°	12°	14°



NOTE:
1.材料：黑色，防静电材料（Denka ECM3）；
2. 10链孔的累积公差不能超过0. 2mm；
3. 250mm带子的扇形不得超过1mm；
4. 所有尺寸符合EIA-481-E的要求。

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